

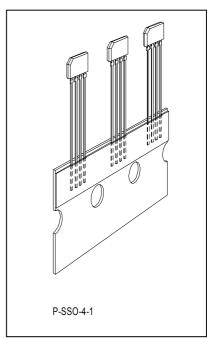
## **High Precision Hall-Effect Switch**

**TLE4966L** 

Data Sheet Version 1.0 2003-11-20

#### **Features**

- 2.7V to 24V supply voltage operation
- Operation from unregulated power supply
- High sensitivity and high stability of the magnetic switching points
- High resistance to mechanical stress by active error compensation
- Reverse battery protection (-18V)
- Superior temperature stability
- Peak temperatures up to 195°C without damage
- Low jitter (typ. 1μs)
- Digital output signal
- Bipolar version
- Excellent matching between the 2 Hall probes
- Hall plate distance 1.45mm
- Direction & speed information
- Direction signal switches 1 μs before the speed signal
- Leaded package P-SSO-4-1



Туре	Ordering Code	Package
TLE4966L	Q62705-K696	P-SSO-4-1

### **Functional Description**

The TLE4966L is an integrated circuit double Hall-effect sensor designed specifically for highly accurate applications. Precise magnetic switching points and high temperature stability are achieved by active compensation circuits and chopper techniques on chip. The TLE4966L provides a speed signal at Q2 for every magnetic pole pair and a direction information at Q1. The direction output switches 1µs (min.) before the speed output.



### **Circuit Description**

The chopped Double Hall Switch comprises two Hall probes, bias generator, compensation circuits, oscillator, and output transistors.

The bias generator provides currents for the Hall probes and the active circuits. Compensation circuits stabilize the temperature behavior and reduce technology variations.

The Active Error Compensation rejects offsets in signal stages and the influence of mechanical stress to the Hall probes caused by molding and soldering processes and other thermal stresses in the package. This chopper technique together with the threshold generator and the comparator ensure high accurate magnetic switching points.

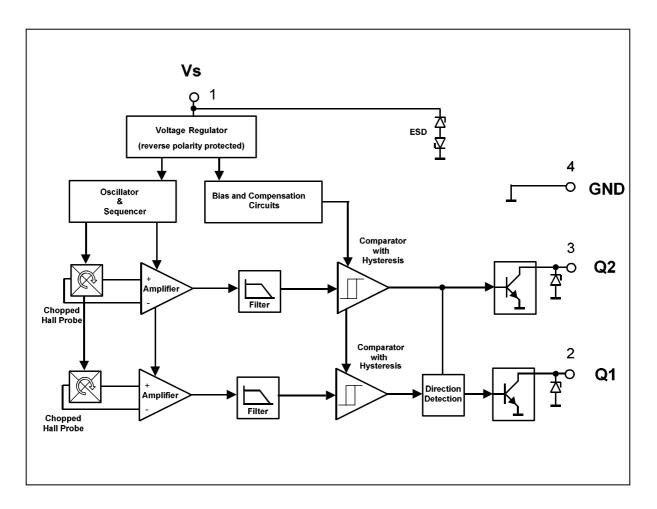


Figure 1: Block Diagram



## **Pin Configuration**

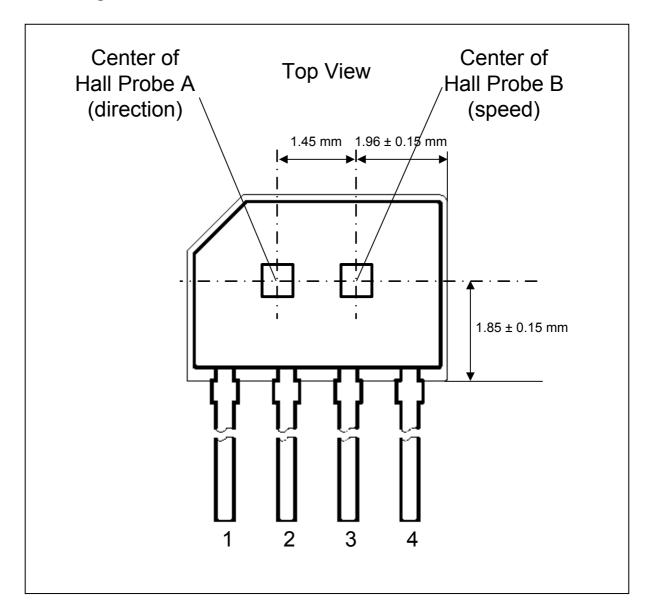


Figure 2: Pin Configuration

### Pin Definition and Functions PSSO package

Pin	Symbol	Function
1	Vs	Supply voltage
2	Q1	Direction
3	Q2	Speed
4	GND	Ground

Data Sheet 3/11 2003-11-20



### **Absolute Maximum Ratings**

 $Tj = -40 \text{ to } 150^{\circ}\text{C}$ 

Parameter	Symbol	min.	max.	Unit	Conditions
Supply Voltage	Vs	-18	18	V	
		-18	24		for 1h ,Rs>=200 Ohm
		-18	26		for 5min, Rs>=200 Ohm
Supply Current through protection device	I <sub>S</sub>	-50	+50	mA	
Output Voltage	VQ	-0.7	18	V	
		-0,7	26		for 5 min @ 1.2 kOhm pull up
Continuous Output Current	ΙQ	-50	+50	mA	
Junction Temperature	Ti	-	155	°C	for 2000 h (not additive)
•	,		165		for 1000 h (not additive)
			175		for 168 h (not additive)
			195		for 3x1 h (additive)
Storage Temperature	Ts	-40	150	°C	
Magnetic Flux Density	В	-	unlimit.	mT	

Note: Stresses above those listed here may cause permanent damage to the device.

Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### **ESD Protection**

Human Body Model (HBM) tests according to:

EOS/ESD Association Standard S5.1-1993 and Mil. Std. 883D method 3015.7

Parameter	Symbol	max.	Unit	Conditions
ESD Voltage	$V_{ESD}$	± 4	kV	HBM, R= 1.500 Ohm, C= 100pF; T <sub>A</sub> = 25°C

## **Operating Range**

Parameter	Symbol	min.	typ.	max.	Unit	Conditions
Supply Voltage	Vs	2.7	-	18	V	
				24		1h with $R_S >= 200 \text{ Ohm}$
				26		for 5min $R_S >= 200 \text{ Ohm}$
Output Voltage	V <sub>Q</sub>	-0.7	-	18	V	
Junction Temperature	T <sub>i</sub>	-40	-	150	°C	
	,			175		for 168 h
Output Current	IQ	0	-	10	mA	

Data Sheet 4/11 2003-11-20



### **AC/DC Characteristics**

over operating range, unless otherwise specified. Typical values correspond to V<sub>S</sub>=12V and  $T_A=25$ °C.

Parameter	Symbol	min.	typ.	max.	Unit	Conditions
Supply Current	I <sub>S</sub>	3	5.5	8	mA	V <sub>S</sub> = 2.7V 18V
Reverse Current	I <sub>SR</sub>	0	0.2	1	mA	V <sub>S</sub> = -18V
Output Saturation Voltage	$V_{QSAT}$	ı	0.3	0.6	V	I <sub>Q</sub> = 10mA
Output Leakage Current	IQ <sub>LEAK</sub>	-	0.05	10	μΑ	for V <sub>Q</sub> =18 V
Output Fall Time	t <sub>f</sub>	-	0.2	1	μs	R <sub>L</sub> = 1.2 kOhm ;C <sub>L</sub> <50pF; Figure 3
Output Rise Time	t <sub>r</sub>	-	0.2	1	μs	R <sub>L</sub> = 1.2 kOhm ;C <sub>L</sub> <50pF; Figure 3
Chopper Frequency	f <sub>OSC</sub>	-	320	-	kHz	
Switching Frequency	$f_{SW}$	0	-	15 <sup>1)</sup>	kHz	
Delay Time <sup>2)</sup>	$t_d$	1	13	-	μs	
Delay of Count Signal	t <sub>d,count</sub>	-	1	-	μs	
Output Jitter <sup>3)</sup>	$t_{QJ}$	ı	1	-	μs <sub>RMS</sub>	Typ. Value for Square-Wave Signal 1kHz
Repeatability of magnetic thresholds <sup>4)</sup>	$B_REP$	-	40	-	μT <sub>RMS</sub>	Typ. Value for ΔB/Δt>12mT/ms
Power-On Time <sup>5)</sup>	t <sub>PON</sub>	-	13	-	μs	$V_{\rm S} > = 2.7 \rm V$
Distance of Hall plates	d <sub>HALL</sub>	-	1.45	-	mm	
Thermal Resistance <sup>6)</sup> P-SSO-4-1	R <sub>thJA</sub>	ı	i	190	K/W	

<sup>1)</sup> To operate the sensor at the max. switching frequency, the value of the magnetic signal amplitude must be 1.4 times higher than for static fields. This is due to the -3dB corner frequency of the low pass filter in the signal path.

<sup>2)</sup> Systematic delay between magnetic threshold reached and output switching.
3) Jitter is the unpredictable deviation of the output switching delay.

 $<sup>^{4)}</sup>$  B<sub>REP</sub> is equivalent to the noise constant.  $^{5)}$  Time from applying V<sub>S</sub> >= 2.7 V to the sensor until the output state is valid.

<sup>&</sup>lt;sup>6)</sup> Thermal resistance from junction to ambient. e.g.:  $V_S$ =12.0 V,  $I_{S\_typ}$ =5.5 mA,  $V_{QSAT\_typ}$ =0.3 V,  $2*I_Q$ =10 mA => Power Dissipation  $P_{dis}$ =72.0mW. In  $T_A$  =  $T_j$  –  $(R_{thJA} * P_{dis})$  = 175 °C – (190 K/W \* 0.072 W) =>  $\underline{T_A}$  = 161.3 °C



## **Magnetic Characteristics**

over operating range, unless otherwise specified. Typical values correspond to V<sub>S</sub>=12V.

Parameter	Symbol	Tj [°C]	min.	typ.	max.	Unit	Conditions
Operate Point	B <sub>OP</sub>					mT	
TLE4966L		-40	5.2	7.7	10.3		
		25	5.0	7.5	10.0		
		150	4.7	7.1	9.5		
Release Point	$B_RP$					mT	
TLE4966L		-40	-10.3	-7.7	-5.2		
		25	-10.0	-7.5	-5.0		
		150	-9.5	-7.1	-4.7		
Hysteresis	B <sub>HYS</sub>					mT	
TLE4966L		-40	-	-	-		
		25	10.0	15.0	20.0		
		150	-	-	-		
Magnetic Matching	B <sub>match</sub>					mT	Valid for B <sub>OP1</sub> -B <sub>OP2</sub>
TLE4966L		-40	-	-	-		and B <sub>RP1</sub> -B <sub>RP2</sub>
		25	-3.0	0	3.0		
		150	-	-	-		
Magnetic Offset	B <sub>OFF</sub>					mT	$(B_{OP}+B_{RP})/2$
TLE4966L		-40	-	-	-		
		25	-3.0	0	3.0		
		150	-	-	-		
Temperature	TC					ppm/°C	
Compensation of		-	-	-350	-		
Magnetic Thresholds							

Positive magnetic fields related with south pole of magnet to the branded side of package. Note: Typical characteristics specify mean values expected over the production spread.



## Timing diagrams for the speed and direction outputs

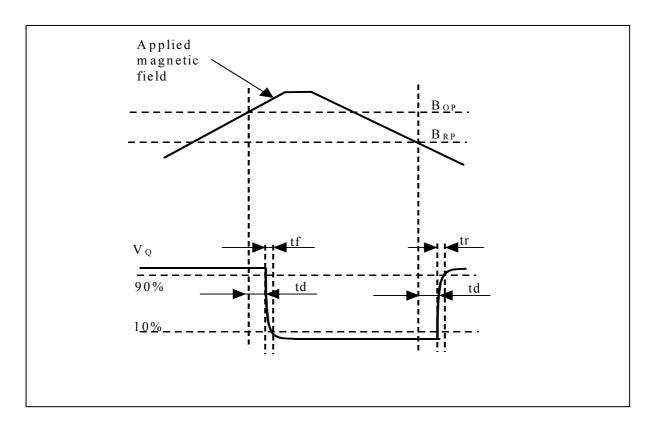


Figure 3: Timing Definition of the Speed Signal



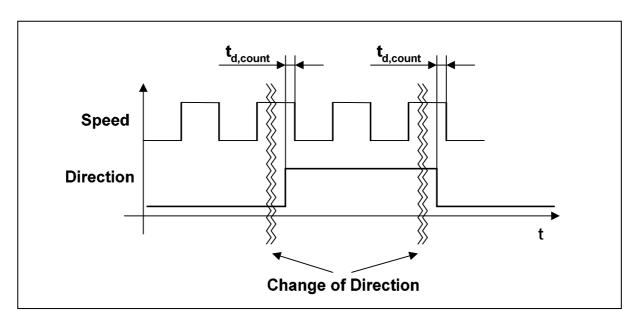


Figure 4: Timing Definition of the Direction Signal

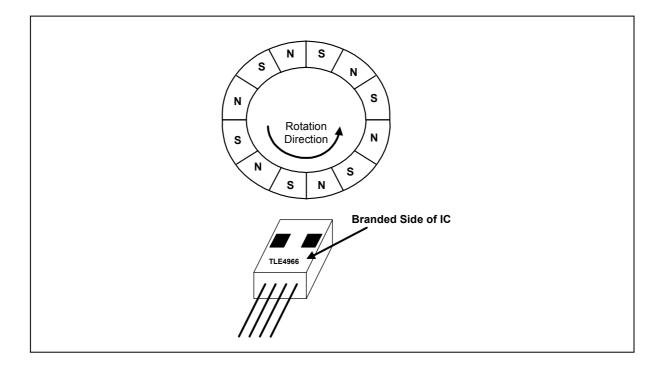


Figure 5: Definition of the Direction Signal

Rotation Direction	State of Direction Output V <sub>Q1</sub>
left to right	low
right to left	high



# **Package Dimensions**

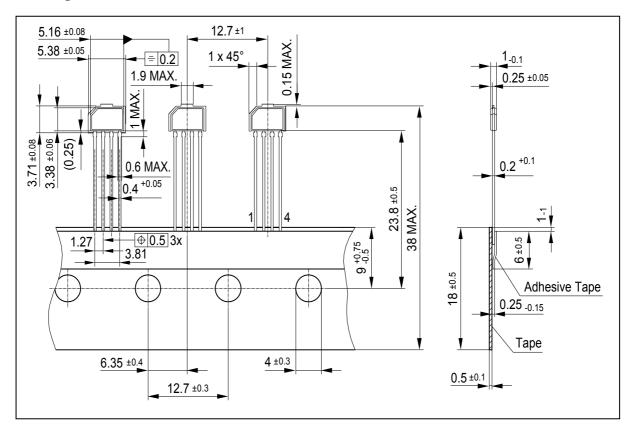


Figure 6: Package Dimension

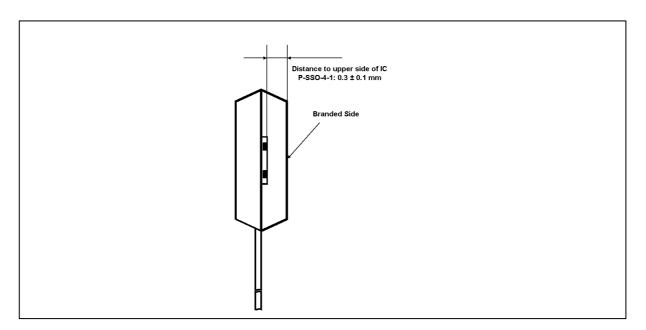


Figure 7: Distance from Package to Die



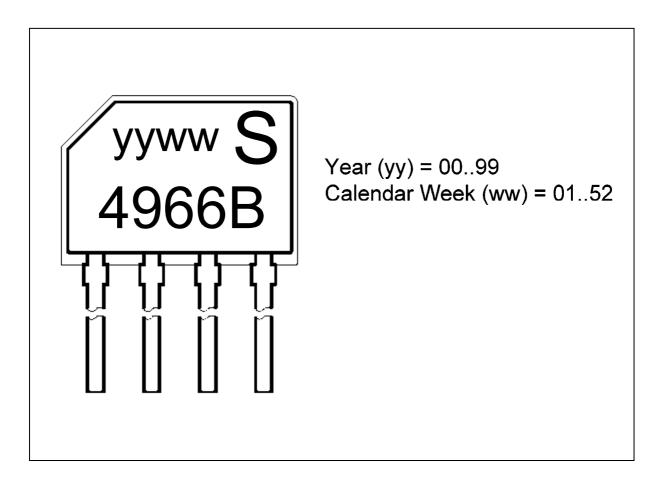


Figure 8: Marking



TLE49661	_	
Revision	History: Version 1.0	2003-11-20
Previous \	Version:	
Page	Subjects (major changes since last revision)	

For questions on technology, delivery and prices please contact the Infineon Technologies Offices in Germany or the Infineon Technologies Companies and Representatives worldwide: see our webpage at http://www.infineon.com

#### We Listen to Your Comments

Any information within this document that you feel is wrong, unclear or missing at all? Your feedback will help us to continuously improve the quality of this document.

Please send your proposal (including a reference to this document) to:

feedback.sensors@infineon.com

Edition 2001-02-22 Published by Infineon Technologies AG St.-Martin-Strasse 53 D-81541 München © Infineon Technologies AG 2000 All Rights Reserved.

#### Attention please!

The information herein is given to describe certain components and shall not be considered as warranted characteristics.

Terms of delivery and rights to technical change reserved.

We hereby disclaim any and all warranties, including but not limited to warranties of non-infringement, regarding circuits, descriptions and charts stated herein.

Infineon Technologies is an approved CECC manufacturer.

#### Information

For further information on technology, delivery terms and conditions and prices please contact your nearest Infineon Technologies Office in Germany or our Infineon Technologies Representatives worldwide (see address list).

#### Warnings

Due to technical requirements components may contain dangerous substances. For information on the types in question please contact your nearest Infineon Technologies Office.

Infineon Technologies Components may only be used in life-support devices or systems with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support device or system, or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body, or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.

Data Sheet 11/11 2003-11-20